SKN 175, SKR 175

Stud Diode

V_{RSM} V	V_{RRM} V	I_{FRMS} =260 A (maximum value for continuous operation) I_{FAV} = 175 A (sin. 180; T_c = 125 ºC)	
800	800	SKN 175/08 [1]	SKR 175/08 [1]
1200	1200	SKN 175/12 [1]	SKR 175/12 [1]

Rectifier Diode

SKN 175
SKR 175

Features

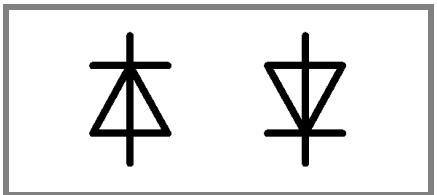
- Reverse voltages up to 1200 V
- Hermetic metal cases with glass insulator
- Threaded stud M12x1,75 mm.
- **SKN:** anode to stud
- **SKR:** cathode to stud

Typical Applications *

- All-purpose mean power rectifier diodes
- Cooling via heatsinks
- Non-controllable and half-controllable rectifiers
- Free-wheeling diodes
- Recommended snubber network:
  R_C: 1,0 µF, 20 Ω (P_R = 2W),
  R_p: 25 kΩ (P_R = 20 W)

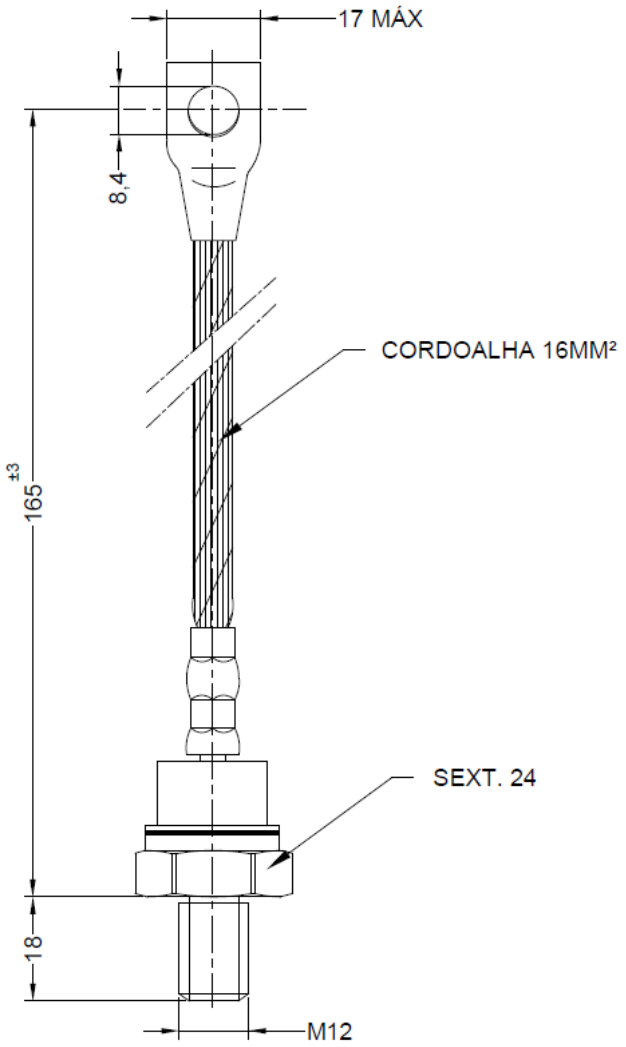
1) To include isolation silicone sleeve, "C/ ESPAG." should be added in description.
2) Mounting with grease-like thermal compound or joint contact compound.

Symbol	Condition	Values	Units
I_{FAV}	sin. 180 ; T_C = 100 (130) ºC	225 (160)	A
I_{FSM}	T_{vj} = 25º C ; 10 ms	4000	A
	T_{vj} = 180º C ; 10 ms	3300	A
i^2t	T_{vj} = 25º C ; 8,3...10 ms	80000	A^2s
	T_{vj} = 180º C ; 8,3...10 ms	54400	A^2s
V_F	T_{vj} = 25º C, I_F = 500 A	max. 1,3	V
$V_{(TO)}$	T_{vj} = 180º C	max. 0,8	V
r_T	T_{vj} = 180º C	max. 1,0	mΩ
I_{RD}	T_{vj} = 180º C ; V_R = V_{RRM}	max. 22	mA
	T_{vj} = 25º C ; V_R = V_{RRM}	max. 1	mA
Q_{rr}	T_{vj} = 160°C, -di_F/dt = 10 A/µs	typ. 80	µC
$R_{th(j-c)}$		0,25	K/W
$R_{th(c-s)}$		0,08	K/W
T_{vj}		-40...+180	°C
T_{stg}		-40...+180	°C
V_{isol}		-	V~
M_s	to heatsink	10	Nm
	to heatsink (lubricated) [2]	7.5	Nm
a		5 * 9,81	m/s^2
m	approx.	100	g
Case		E14	



SKN SKR

Dimensions in mm



Case E15 (IEC 60191:A 9 MA modified; JEDEC: DO-205 AC)

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